December 2001

FDW2508P

FAIRCHILD SEMICONDUCTOR®

Dual P-Channel 1.8 V Specified PowerTrench[®] MOSFET

General Description

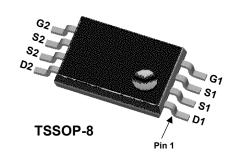
This P-Channel –1.8V specified MOSFET uses Fairchild's advanced low voltage PowerTrench process. It has been optimized for battery power management applications.

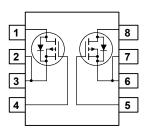
Applications

- Power management
- Load switch
- Battery protection

Features

- Low gate charge(26nC typical)
- High performance trench technology for extremely
 low R_{DS(ON)}
- Low profile TSSOP-8 package





Absolute Maximum Ratings T_A=25°C unless otherwise noted

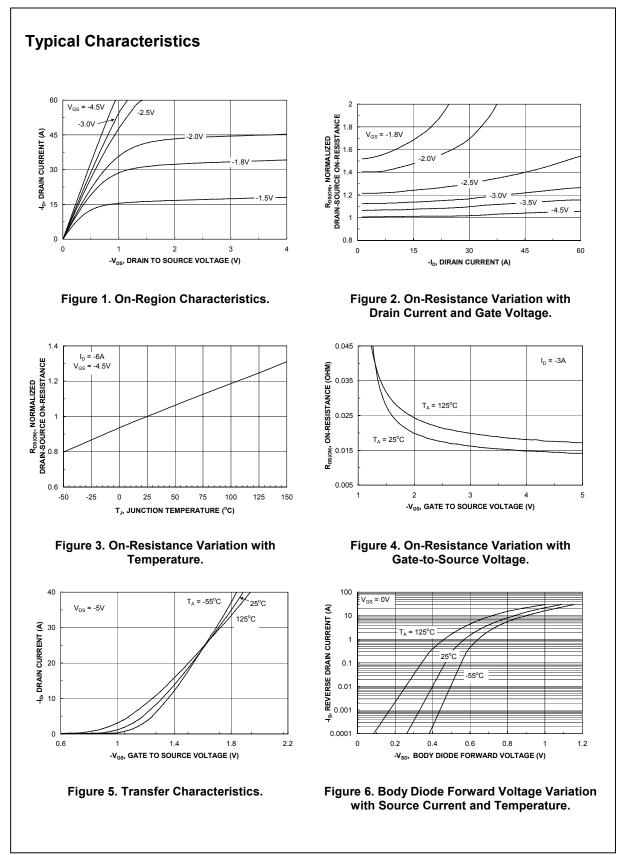
Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Source Voltage	rce Voltage		V	
V _{GSS}	Gate-Source Voltage	rce Voltage		V	
ID	Drain Current – Continuous (Note 1)		6	A	
	– Pulsed	-30			
P _D	Power Dissipation for Single Operat	tion (Note 1a)	1.3	W	
		(Note 1b)	1		
		(NOLE ID)	•		
	Operating and Storage Junction Ter	, <i>,</i>	-55 to +150	°C	
Therma	Operating and Storage Junction Ter I Characteristics Thermal Resistance, Junction-to-An	mperature Range	-55 to +150 100	°C	
T _J , T _{STG} Therma R _{θJA}	I Characteristics	mperature Range			
Therma _{Rөл} Packag	I Characteristics Thermal Resistance, Junction-to-An e Marking and Ordering	nbient (Note 1a) (Note 1b)	100 125	•C/W	
Therma _{Rөла} Packag	I Characteristics Thermal Resistance, Junction-to-An	nbient (Note 1a) (Note 1b)	100		

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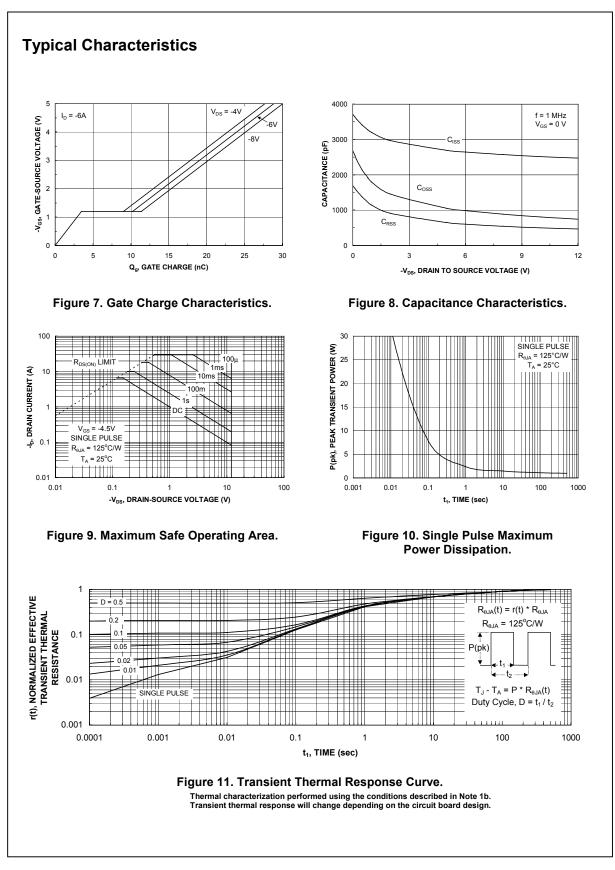
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-12			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		-2		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -10 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
	Gate–Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = -250 \ \mu A$	-0.4	-0.5	-1.5	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA, Referenced to 25°C		2.7		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = -4.5 V, I_D = -6 A$ $V_{GS} = -2.5 V, I_D = -5 A$ $V_{GS} = -1.8 V, I_D = -4 A$ $V_{GS} = -4.5 V, I_D = -6A, T_J = 125^{\circ}C$		14 17 22 18	18 22 30 25	mΩ
I _{D(on)}	On–State Drain Current	$ \begin{array}{l} V_{GS} = -4.5 \ V, \ I_D = -6A, \ T_J = 125^{\circ}C \\ V_{GS} = -4.5 \ V, \ \ V_{DS} = -5 \ V \end{array} $	-30			A
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_{D} = -6 A$		32		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = -6 V$, $V_{GS} = 0 V$,		2644		pF
Coss	Output Capacitance	f = 1.0 MHz		987		pF
C _{rss}	Reverse Transfer Capacitance			602		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -6 V, \qquad I_D = -1 A,$		14	25	ns
t _r	Turn–On Rise Time	$V_{GS} = -4.5 \text{ V}, R_{GEN} = 6 \Omega$		9.1	18	ns
t _{d(off)}	Turn–Off Delay Time			122	195	ns
t _f	Turn–Off Fall Time			89	142	ns
Qg	Total Gate Charge	$V_{DS} = -6 V$, $I_D = -6 A$,		26	36	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = -4.5 V$		4		nC
Q _{gd}	Gate–Drain Charge			7		nC
Drain-So	ource Diode Characteristics					
ls	Maximum Continuous Drain-Source				-1.1	A
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -1.1 A$ (Note 2)		-0.59	-1.2	V
		mal resistance where the case thermal reference mined by the user's board design.	is defined	as the sold	ler mountin	g surface c

2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



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